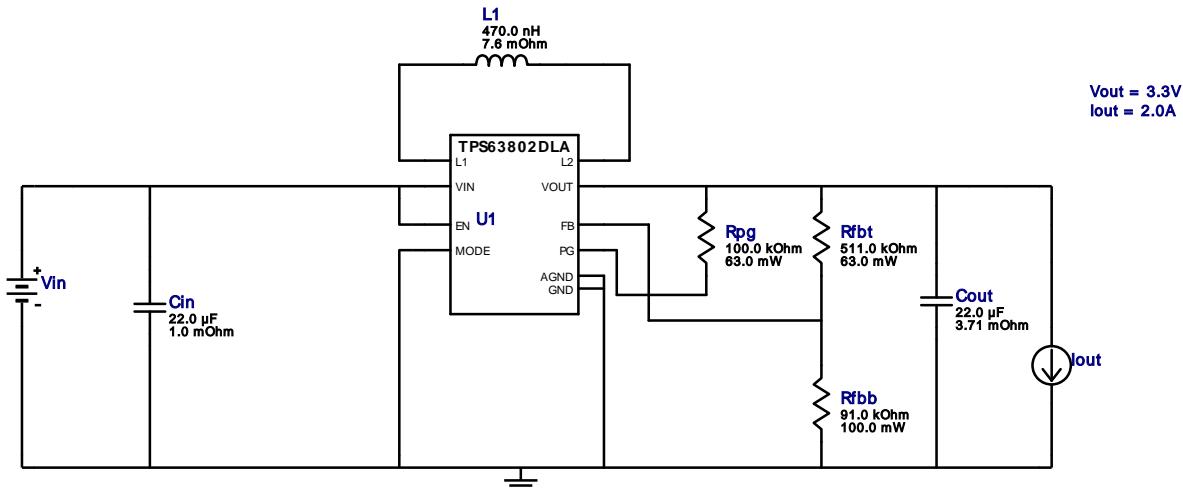


WEBENCH® Design Report

Design : 35 TPS63802DLAR
 TPS63802DLAR 1.5V-5.5V to 3.30V @ 2A

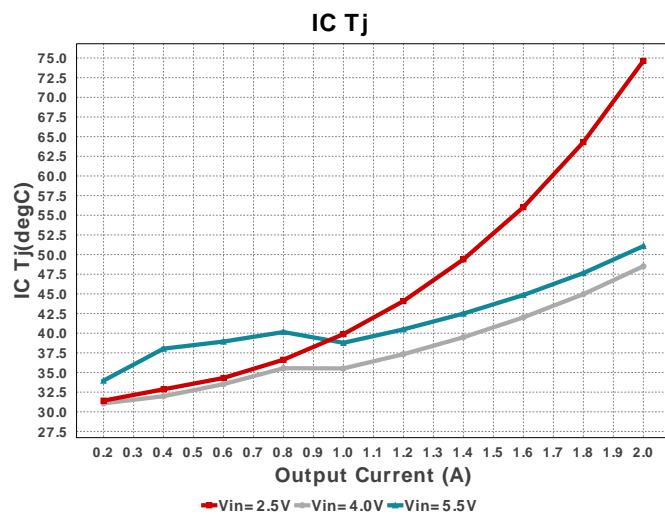
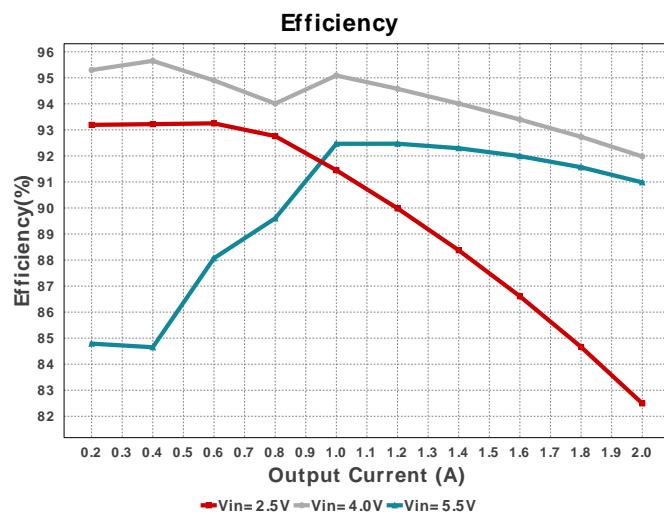
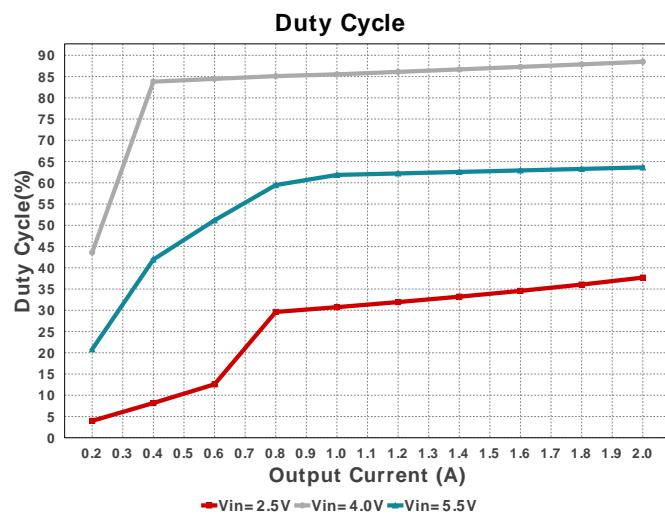
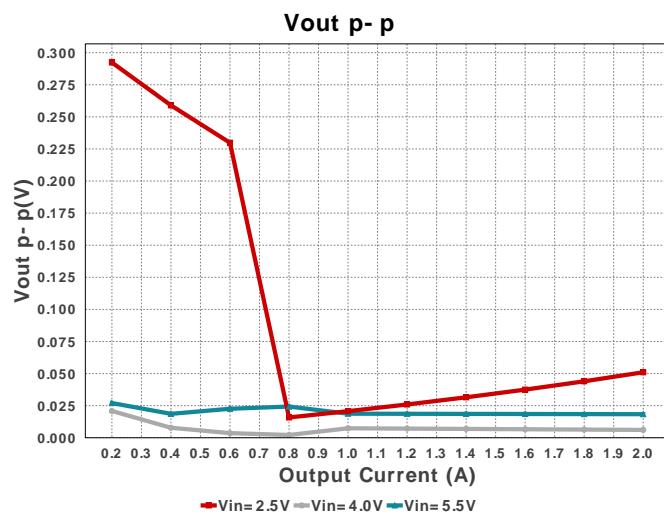
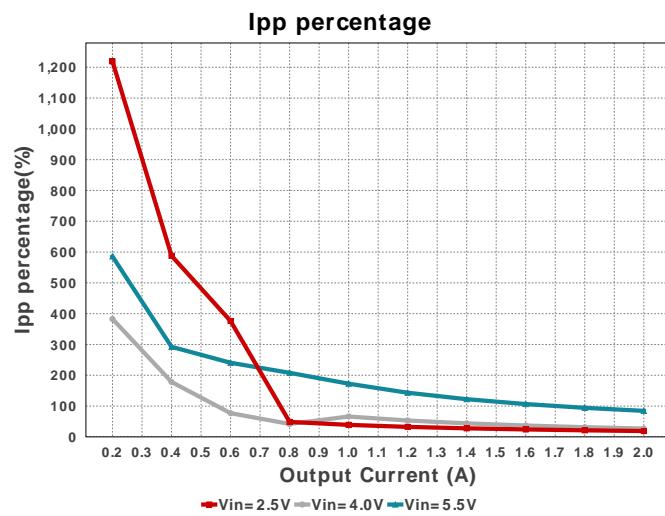
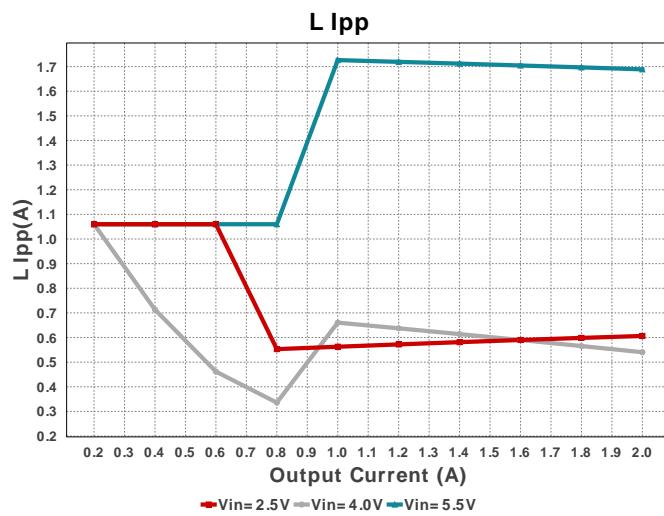
VinMin = 2.5V
 VinMax = 5.5V
 Vout = 3.3V
 Iout = 2.0A

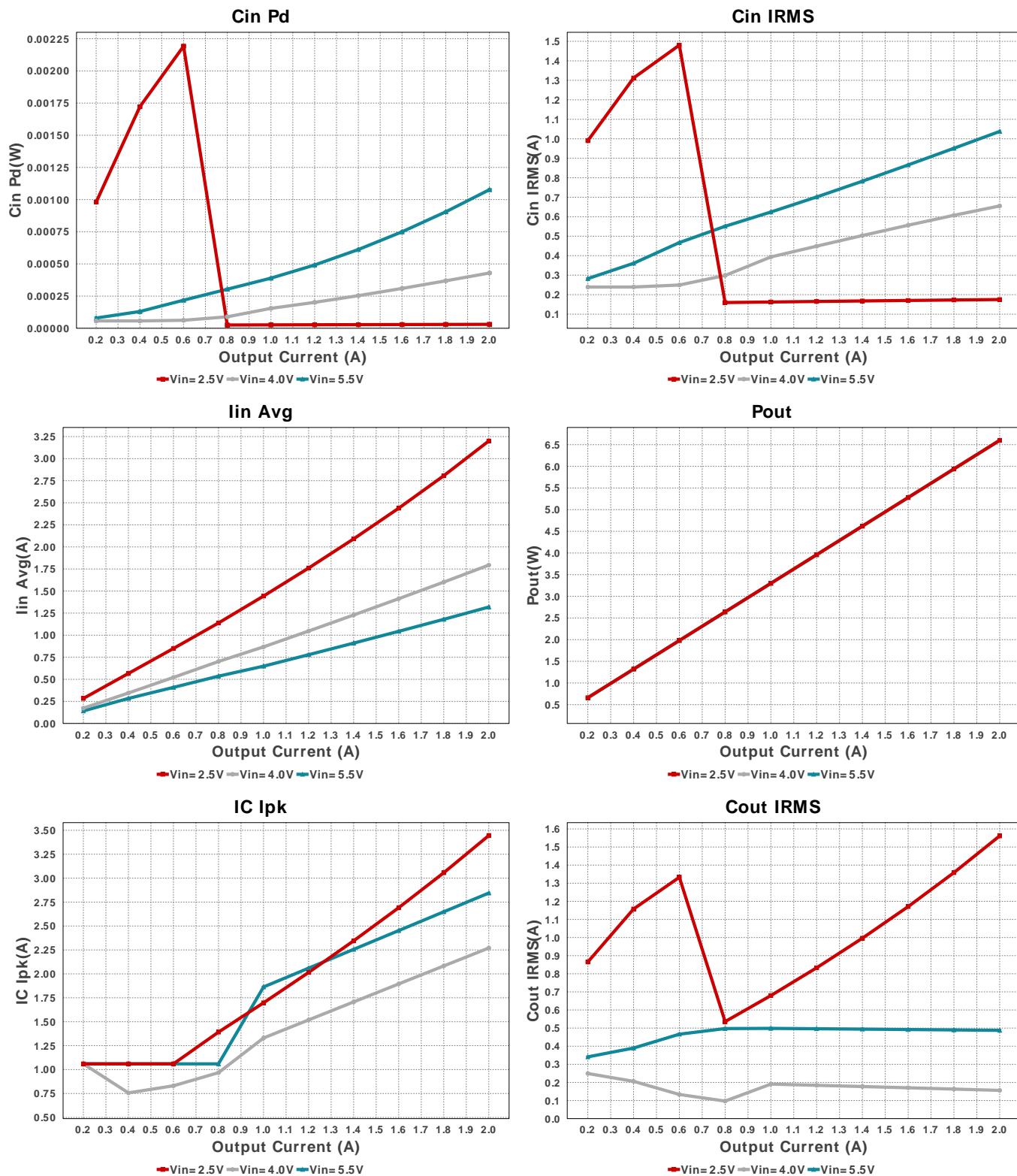
Device = TPS63802DLAR
 Topology = Buck_Boost
 Created = 2020-11-01 22:46:34.589
 BOM Cost = \$1.66
 BOM Count = 7
 Total Pd = 1.4W

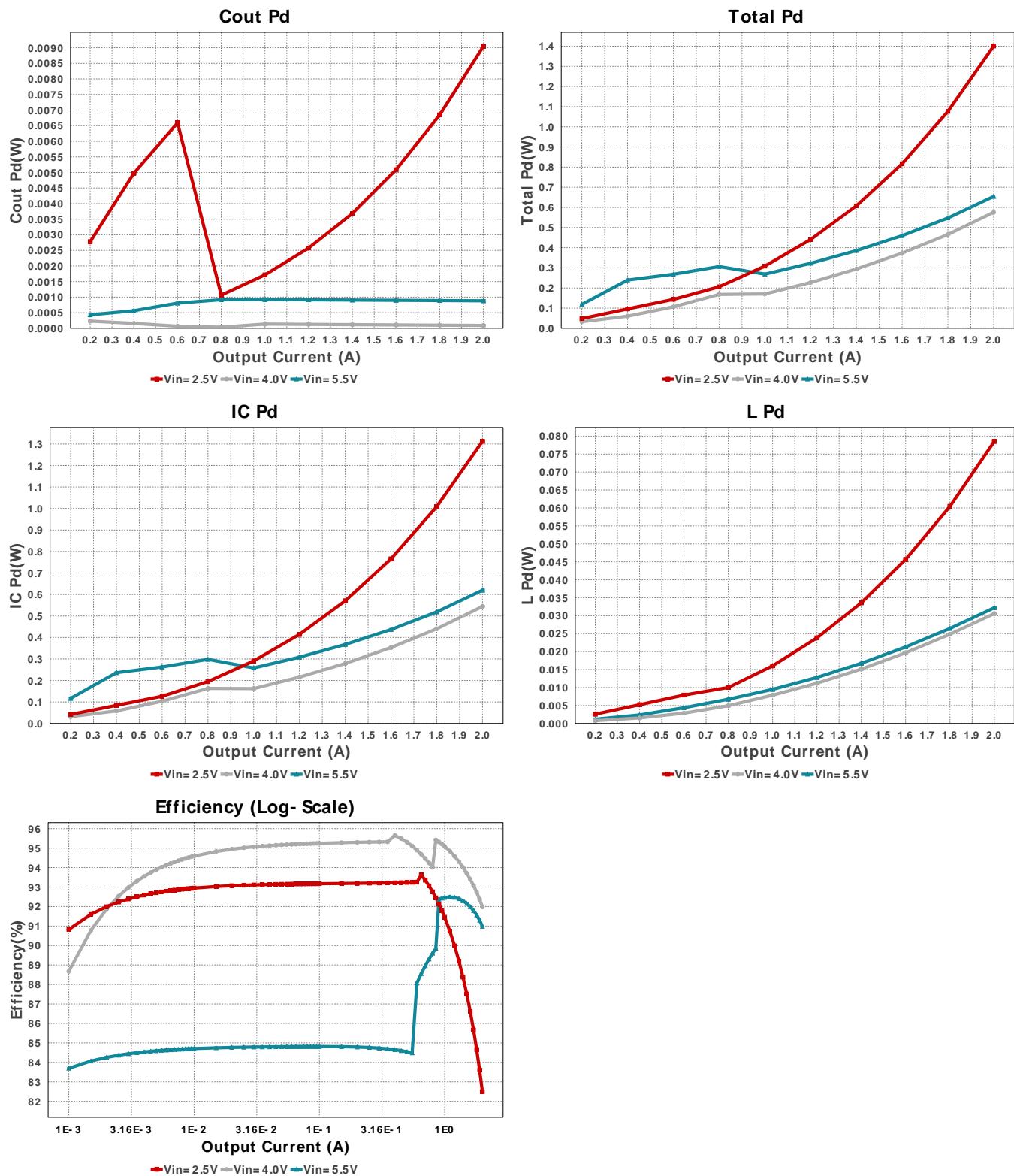


Electrical BOM

| Name | Manufacturer | Part Number | Properties | Qty | Price | Footprint |
|------|-------------------|--------------------------------------|--|-----|--------|---------------------|
| Cin | MuRata | GRM188R60J226MEA0D Series= X5R | Cap= 22.0 uF ESR= 1.0 mOhm VDC= 6.3 V IRMS= 6.0 A | 1 | \$0.05 | ■ 0603 5 mm² |
| Cout | TDK | C1608X5R1A226M080AC Series= X5R | Cap= 22.0 uF ESR= 3.71 mOhm VDC= 10.0 V IRMS= 2.69936 A | 1 | \$0.12 | ■ 0603 5 mm² |
| L1 | Coilcraft | XFL4015-471MEB | L= 470.0 nH 7.6 mOhm | 1 | \$0.60 | ■ XFL4015 28 mm² |
| Rfbb | Yageo | RC0603FR-0791KL Series= ? | Res= 91.0 kOhm Power= 100.0 mW Tolerance= 1.0% | 1 | \$0.01 | ■ 0603 5 mm² |
| Rfbt | Vishay-Dale | CRCW0402511KFKED Series= CRCW..e3 | Res= 511.0 kOhm Power= 63.0 mW Tolerance= 1.0% | 1 | \$0.01 | ■ 0402 3 mm² |
| Rpg | Vishay-Dale | CRCW0402100KFKED Series= CRCW..e3 | Res= 100.0 kOhm Power= 63.0 mW Tolerance= 1.0% | 1 | \$0.01 | ■ 0402 3 mm² |
| U1 | Texas Instruments | TPS63802DLAR | Switcher | 1 | \$0.86 | DLA0010A 12 mm² |







Operating Values

| # | Name | Value | Category | Description |
|-----|--------------|----------------|-----------|---|
| 1. | Cin IRMS | 175.046 mA | Capacitor | Input capacitor RMS ripple current |
| 2. | Cin Pd | 30.641 μ W | Capacitor | Input capacitor power dissipation |
| 3. | Cout IRMS | 1.561 A | Capacitor | Output capacitor RMS ripple current |
| 4. | Cout Pd | 9.046 mW | Capacitor | Output capacitor power dissipation |
| 5. | IC Ipk | 3.445 A | IC | Peak switch current in IC |
| 6. | IC Pd | 1.313 W | IC | IC power dissipation |
| 7. | IC Tj | 74.638 degC | IC | IC junction temperature |
| 8. | IC Tolerance | 5.0 mV | IC | IC Feedback Tolerance |
| 9. | ICThetaJA | 34.0 degC/W | IC | IC junction-to-ambient thermal resistance |
| 10. | Iin Avg | 3.2 A | IC | Average input current |

| # | Name | Value | Category | Description |
|-----|----------------|----------------------|--------------------|--|
| 11. | Ipp percentage | 18.893 % | Inductor | Inductor ripple current percentage (with respect to average inductor current) |
| 12. | L Ipp | 606.38 mA | Inductor | Peak-to-peak inductor ripple current |
| 13. | L Pd | 78.521 mW | Inductor | Inductor power dissipation |
| 14. | Cin Pd | 30.641 μ W | Power | Input capacitor power dissipation |
| 15. | Cout Pd | 9.046 mW | Power | Output capacitor power dissipation |
| 16. | IC Pd | 1.313 W | Power | IC power dissipation |
| 17. | L Pd | 78.521 mW | Power | Inductor power dissipation |
| 18. | Total Pd | 1.4 W | Power | Total Power Dissipation |
| 19. | BOM Count | 7 | System Information | Total Design BOM count |
| 20. | Duty Cycle | 37.686 % | System Information | Duty cycle |
| 21. | Efficiency | 82.495 % | System Information | Steady state efficiency |
| 22. | FootPrint | 60.0 mm ² | System Information | Total Foot Print Area of BOM components |
| 23. | Frequency | 2.52 MHz | System Information | Switching frequency |
| 24. | Iout | 2.0 A | System Information | Iout operating point |
| 25. | Mode | CCM | System Information | Conduction Mode |
| 26. | Pout | 6.6 W | System Information | Total output power |
| 27. | Total BOM | \$1.66 | System Information | Total BOM Cost |
| 28. | Vin | 2.5 V | System Information | Vin operating point |
| 29. | Vout | 3.3 V | System Information | Operational Output Voltage |
| 30. | Vout Actual | 3.308 V | System Information | Vout Actual calculated based on selected voltage divider resistors |
| 31. | Vout Tolerance | 2.732 % | System Information | Vout Tolerance based on IC Tolerance (no load) and voltage divider resistors if applicable |
| 32. | Vout p-p | 51.018 mV | System Information | Peak-to-peak output ripple voltage |

Design Inputs

| Name | Value | Description |
|---------|----------|------------------------|
| Iout | 2.0 | Maximum Output Current |
| VinMax | 5.5 | Maximum input voltage |
| VinMin | 2.5 | Minimum input voltage |
| Vout | 3.3 | Output Voltage |
| base_pn | TPS63802 | Base Product Number |
| source | DC | Input Source Type |
| Ta | 30.0 | Ambient temperature |

WEBENCH® Assembly

Component Testing

Some published data on components in datasheets such as Capacitor ESR and Inductor DC resistance is based on conservative values that will guarantee that the components always exceed the specification. For design purposes it is usually better to work with typical values. Since this data is not always available it is a good practice to measure the Capacitance and ESR values of C_{in} and C_{out} , and the inductance and DC resistance of L_1 before assembly of the board. Any large discrepancies in values should be electrically simulated in WEBENCH to check for instabilities and thermally simulated in WebTHERM to make sure critical temperatures are not exceeded.

Soldering Component to Board

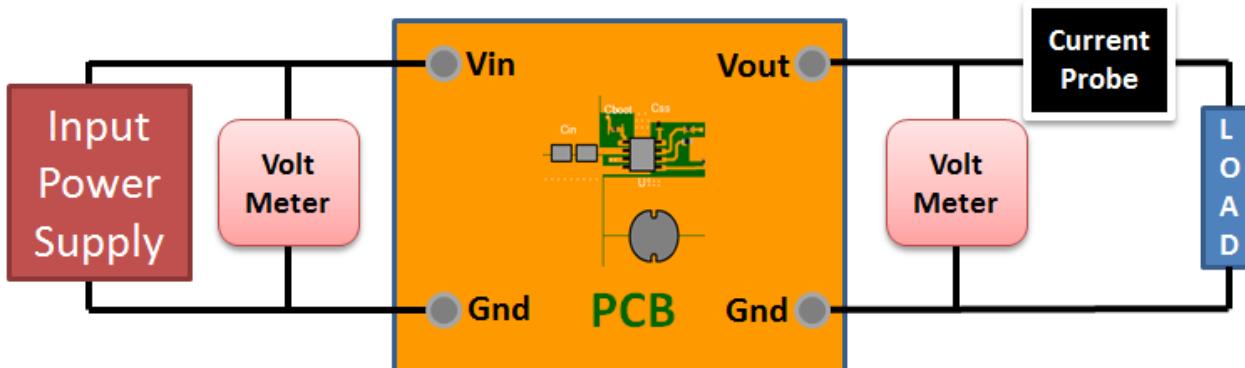
If board assembly is done in house it is best to tack down one terminal of a component on the board then solder the other terminal. For surface mount parts with large tabs, such as the DPAK, the tab on the back of the package should be pre-tinned with solder, then tacked into place by one of the pins. To solder the tab down to the board place the iron down on the board while resting against the tab, heating both surfaces simultaneously. Apply light pressure to the top of the plastic case until the solder flows around the part and the part is flush with the PCB. If the solder is not flowing around the board you may need a higher wattage iron (generally 25W to 30W is enough).

Initial Startup of Circuit

It is best to initially power up the board by setting the input supply voltage to the lowest operating input voltage 2.5V and set the input supply's current limit to zero. With the input supply off connect up the input supply to V_{in} and GND. Connect a digital volt meter and a load if needed to set the minimum I_{out} of the design from V_{out} and GND. Turn on the input supply and slowly turn up the current limit on the input supply. If the voltage starts to rise on the input supply continue increasing the input supply current limit while watching the output voltage. If the current increases on the input supply, but the voltage remains near zero, then there may be a short or a component misplaced on the board. Power down the board and visually inspect for solder bridges and recheck the diode and capacitor polarities. Once the power supply circuit is operational then more extensive testing may include full load testing, transient load and line tests to compare with simulation results.

Load Testing

The setup is the same as the initial startup, except that an additional digital voltmeter is connected between V_{in} and GND, a load is connected between V_{out} and GND and a current meter is connected in series between V_{out} and the load. The load must be able to handle at least rated output power + 50% (7.5 watts for this design). Ideally the load is supplied in the form of a variable load test unit. It can also be done in the form of suitably large power resistors. When using an oscilloscope to measure waveforms on the prototype board, the ground leads of the oscilloscope probes should be as short as possible and the area of the loop formed by the ground lead should be kept to a minimum. This will help reduce ground lead inductance and eliminate EMI noise that is not actually present in the circuit.

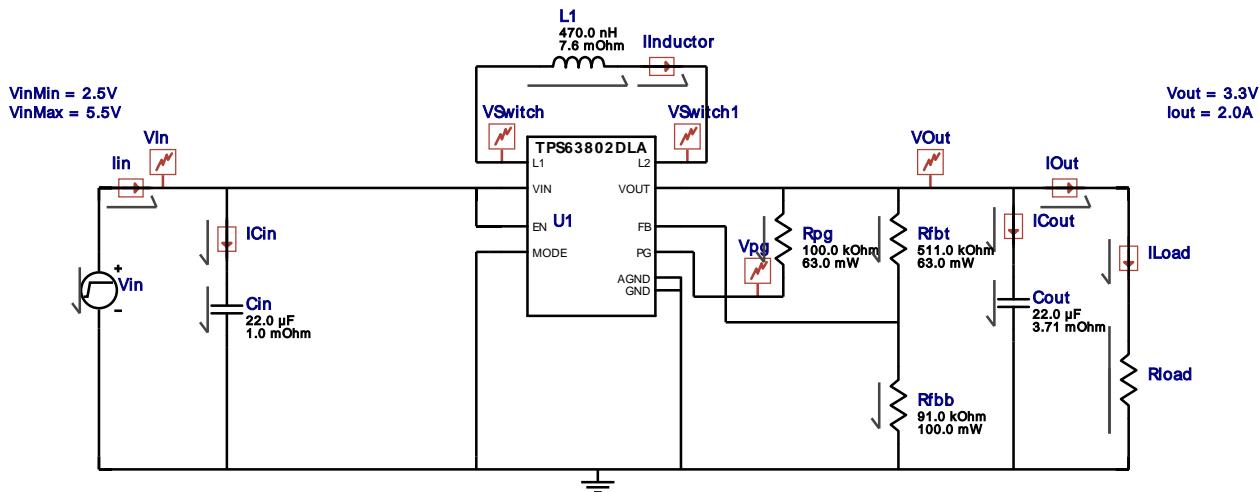


WEBENCH® Electrical Simulation Report

Design Id = 35

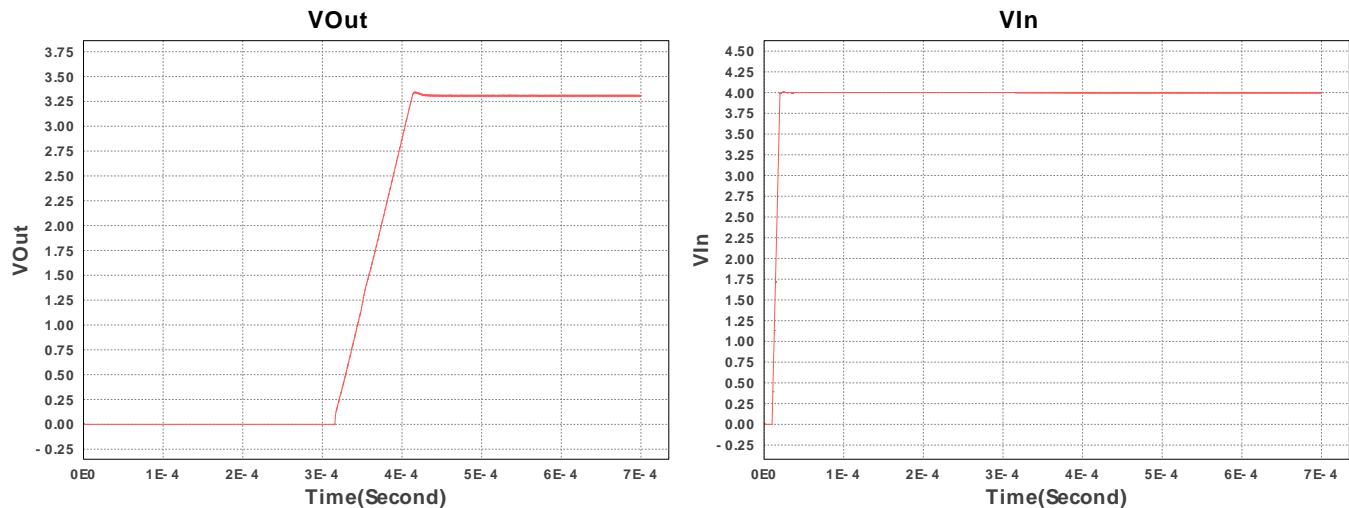
sim_id = 1

Simulation Type = Startup



Simulation Parameters

| # | Name | Parameter Name | Description | Values |
|----|--------|----------------|-----------------|----------|
| 1. | Vzero1 | Vmode | no description | 0 |
| 2. | Vzero1 | Ven | no description | 0 |
| 3. | Rload | R | Load Resistance | 1.65 Ohm |



Design Assistance

- Master key : 43997ABFD357DFEF[v1]
- TPS63802 Product Folder : <http://www.ti.com/product/TPS63802> : contains the data sheet and other resources.

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